NEC

DATA SHEET

PHOTOCOUPLER PS2711-1

HIGH CTR 4-PIN SOP PHOTOCOUPLER

-NEPOC[™] Series-

DESCRIPTION

The PS2711-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor in a plastic SOP for high density applications.

The package is an SOP (Small Outline Package) type for high density mounting applications.

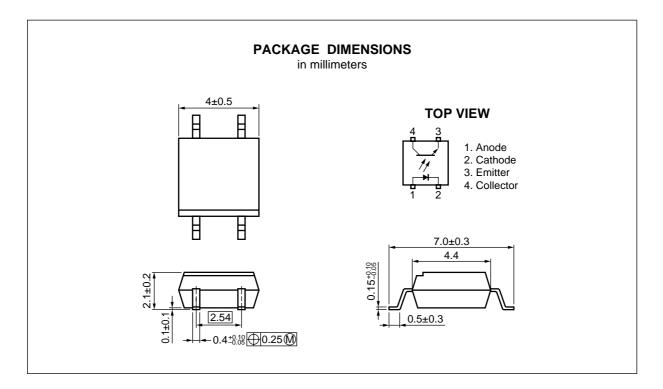
FEATURES

- High current transfer ratio (CTR = 200 % TYP. @ I_F = 1mA)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- Small and thin package (4-pin SOP)
- Ordering number of tape product: PS2711-1-F3, F4
- UL approved: File No. E72422 (S)

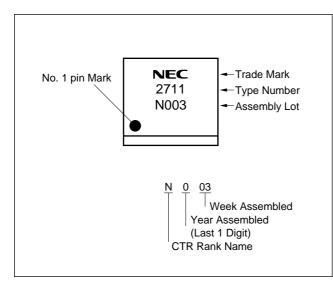
APPLICATIONS

- Programmable logic controllers
- Small power supply
- Hybrid IC
- Modem/FAX

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MARKING



ORDERING INFORMATION

Part Number	Package	Packing Style	Safety Standards Approval	Application Part Number ^{*1}
PS2711-1	4-pin SOP	50 pcs (Tape 50 pcs cut)	UL approved	PS2711-1
PS2711-1-F3		Embossed Tape 3 500 pcs/reel		
PS2711-1-F4				

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)	lf	50	mA	
	Reverse Voltage	VR	6	V	
	Power Dissipation Derating	⊿P _D /°C	0.8	mW/°C	
	Power Dissipation	PD	80	mW	
	Peak Forward Current ¹	IFP	0.5	А	
Transistor	Collector to Emitter Voltage	Vceo	40	V	
	Emitter to Collector Voltage	Veco	5	V	
	Collector Current	lc	40	mA	
	Power Dissipation Derating	∆Pc/°C	1.5	mW/°C	
	Power Dissipation	Pc	150	mW	
Isolation Voltage ²		BV	3 750	Vr.m.s.	
Operating Ambient Temperature		TA	–55 to +100	°C	
Storage Temperature		Tstg	–55 to +150	°C	

*1 PW = 100 μ s, Duty Cycle = 1 %

*2 AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

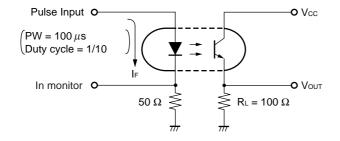
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 5 mA		1.15	1.4	V
	Reverse Current	Ir	V _R = 5 V			5	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		30		pF
Transistor	Collector to Emitter Dark Current	Iceo	IF = 0 mA, VCE = 40 V			100	nA
Coupled	Current Transfer Ratio (Ic/IF) ^{*1}	CTR	IF = 1 mA, Vce = 5 V	100	200	400	%
	Collector Saturation Voltage	Vce (sat)	IF = 1 mA, Ic = 0.2 mA			0.3	V
	Isolation Resistance	Ri-o	VI-0 = 1 kVDC	10 ¹¹			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1 MHz		0.4		pF
	Rise Time ^{*2}	tr	$V_{CC} = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ RL} = 100 \Omega$		4		μs
	Fall Time ^{*2}	tr			5		

*1 CTR rank

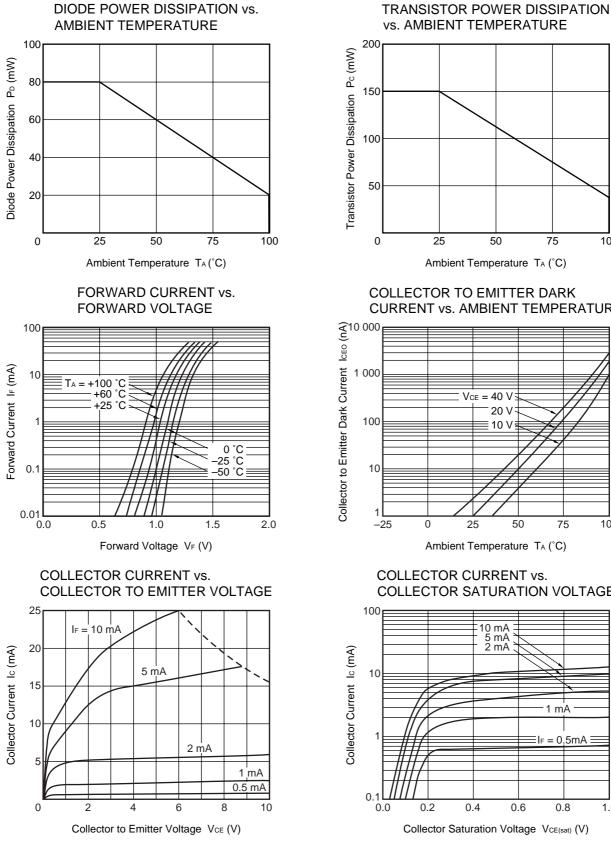
- N : 100 to 400 (%)
- K : 200 to 400 (%)

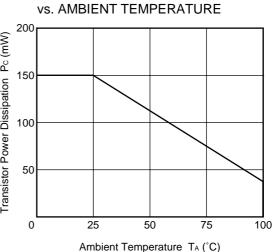
L : 150 to 300 (%)

- M: 100 to 200 (%)
- *2 Test circuit for switching time

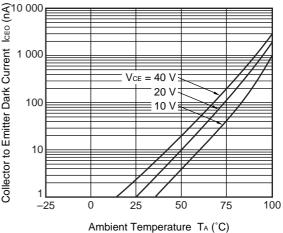


TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)

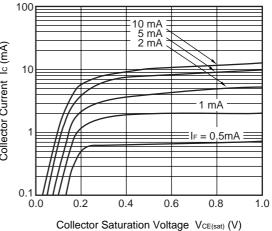


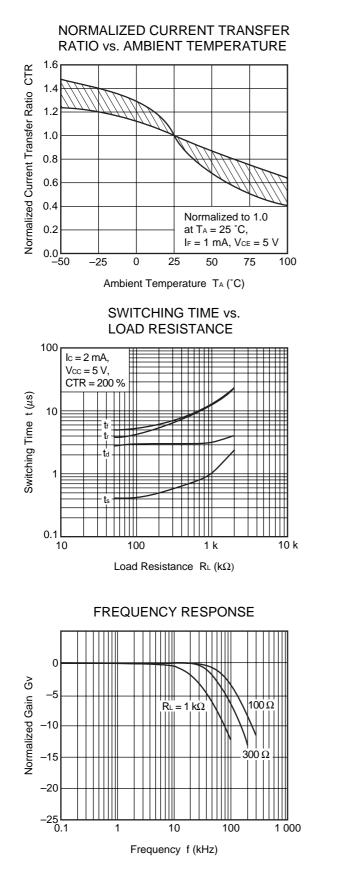


COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE



COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE

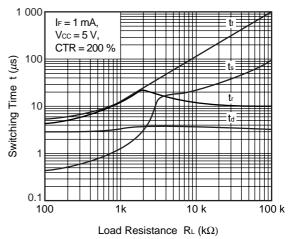




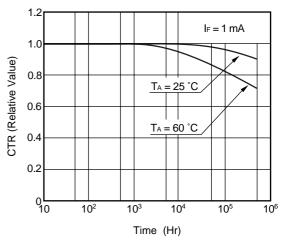
Remark The graphs indicate nominal characteristics.

CURRENT TRANSFER RATIO vs. FORWARD CURRENT 500 Vce = 5 V, n = 3 Current Transfer Ratio CTR (%) 400 300 200 100 0 0.01 0.1 10 100 1 Forward Current IF (mA)

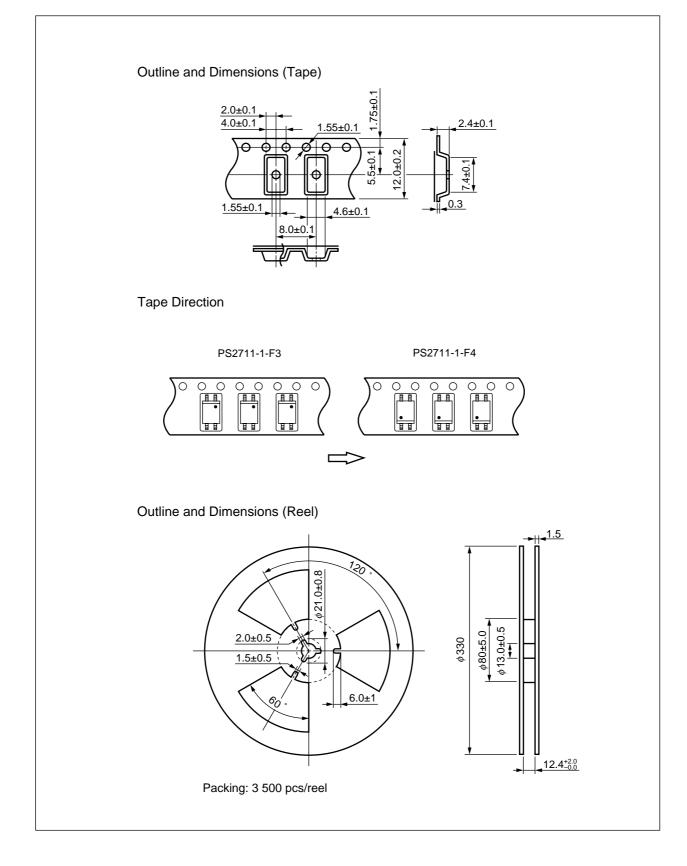
SWITCHING TIME vs. LOAD RESISTANCE



LONG TERM CTR DEGRADATION



TAPING SPECIFICATIONS (in millimeters)



NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

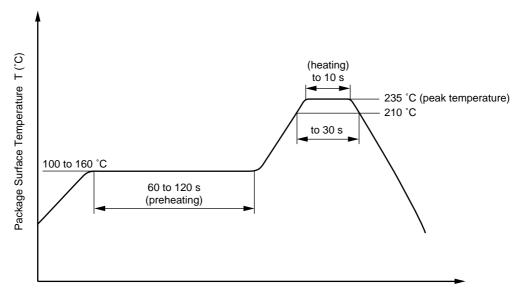
- · Peak reflow temperature
- Time of temperature higher than 210 °C
- Number of reflows
- Flux

235 °C or below (package surface temperature) 30 seconds or less

Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

Recommended Temperature Profile of Infrared Reflow





(2) Dip soldering

- Temperature 260 °C or below (molten solder temperature)
- Time 10 seconds or less
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
 - Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(3) Cautions

• Flux

· Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between corrector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

[MEMO]

[MEMO]

[MEMO]

CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.

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